

# 30A, 45V Schottky Barrier Surface Mount Rectifier

#### **FEATURES**

- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- Guard ring for overvoltage protection
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- Low voltage, high freq. inverter
- DC/DC converter
- · Freewheeling diodes
- Reverse battery protection
- Car lighting

#### **MECHANICAL DATA**

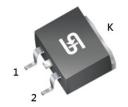
- Case: TO-263AB (D<sup>2</sup>PAK)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 1.41g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	30	Α	
$V_{RRM}$	45	V	
I <sub>FSM</sub>	220	Α	
T <sub>J MAX</sub>	175	°C	
Package	TO-263AB (D <sup>2</sup> PAK)		
Configuration	Dual dies		









TO-263AB (D<sup>2</sup>PAK)



ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless PARAMETER	SYMBOL	MBRS30H45CTH	UNIT
Marking code on the device	31 MBOL	MBRS30H45CT	
Repetitive peak reverse voltage	$V_{RRM}$	45	V
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	31	V
Forward current	I <sub>F</sub>	30	А
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	I <sub>FSM</sub>	220	Α
Critical rate of rise of off-state voltage	dv/dt	10,000	V/µs
Junction temperature	T <sub>J</sub>	-55 to +175	°C
Storage temperature	T <sub>STG</sub>	-55 to +175	°C

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THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	50	°C/W
Junction-to-case thermal resistance	R <sub>eJC</sub>	1.5	°C/W

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode (1)	I <sub>F</sub> = 15A, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	0.70	V
	$I_F = 30A, T_J = 25^{\circ}C$		-	0.90	V
	I <sub>F</sub> = 15A, T <sub>J</sub> = 125°C		-	0.60	V
	I <sub>F</sub> = 30A, T <sub>J</sub> = 125°C		-	0.75	V
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>	T <sub>J</sub> = 25°C		-	200	μΑ
	T <sub>J</sub> = 125°C	l <sub>R</sub>	-	15	mA

#### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

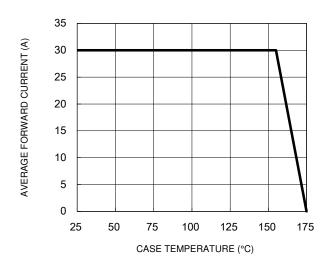
ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
MBRS30H45CTH	TO-263AB (D <sup>2</sup> PAK)	800 / Tape & Reel	



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 



**Fig.2 Typical Junction Capacitance** 

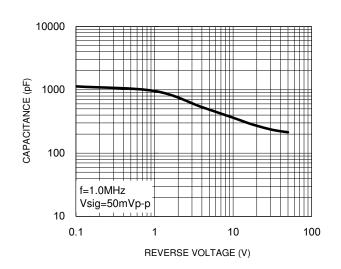
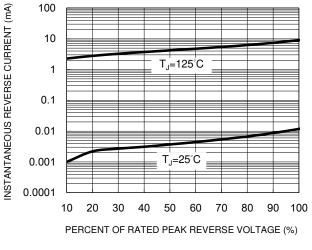


Fig.3 Typical Reverse Characteristics





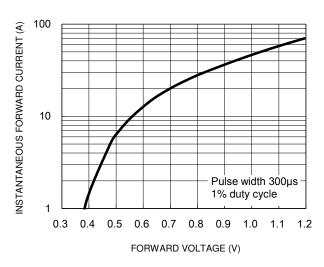
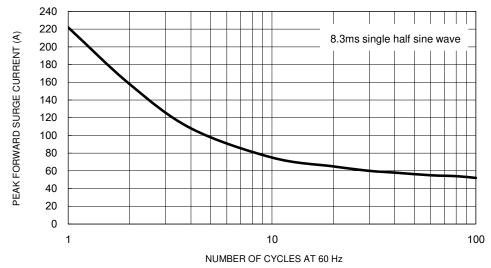


Fig.5 Maximum Non-Repetitive Forward Surge Current



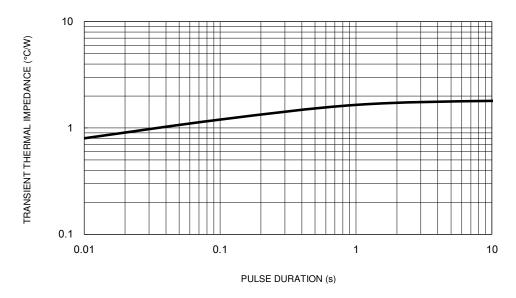
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## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

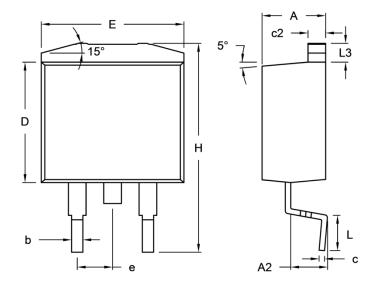
Fig.6 Typical Transient Thermal Impedance





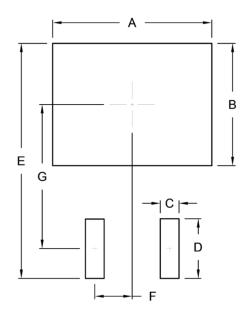
## **PACKAGE OUTLINE DIMENSIONS**

# TO-263AB (D<sup>2</sup>PAK)



DIM.	Unit (mm)		Unit	(inch)	
DIW.	Min.	Max.	Min.	Max.	
Α	4.44	4.70	0.175	0.185	
A2	2.03	2.79	0.080	0.110	
b	0.68	0.94	0.027	0.037	
С	0.36	0.53	0.014	0.021	
c2	1.14	1.40	0.045	0.055	
D	8.25	9.25	0.325	0.364	
E	-	10.50	-	0.413	
е	2.41	2.67	0.095	0.105	
Н	14.60	15.88	0.575	0.625	
L	2.29	2.79	0.090	0.110	
L3	1.14	1.40	0.045	0.055	

### **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	10.80	0.425
В	8.30	0.327
С	1.27	0.050
D	4.05	0.159
E	15.95	0.628
F	2.54	0.100
G	9.775	0.385

### **MARKING DIAGRAM**



P/N = Marking Code G = Green Compound

YWW = Date Code F = Factory Code



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